

MOSFET

OptiMOS[™]5 Power-Transistor, 80 V

Features

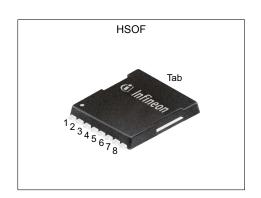
- Optimized for battery powered applications
- Excellent gate charge x R_{DS(on)} product (FOM)
 Very low on-resistance R_{DS(on)}
- N-channel, normal level
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
 Qualified according to JEDEC¹⁾ for target applications
 Halogen-free according to IEC61249-2-21

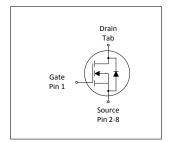


Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

Parameter	Value	Unit					
V _{DS}	80	V					
R _{DS(on),max}	1.4	mΩ					
I_{D}	331	A					
Qoss	187	nC					
Q _G (0V10V)	160	nC					











Type / Ordering Code	Package	Marking	Related Links
IPT014N08NM5	PG-HSOF-8	014N08N5	-

OptiMOSTM5 Power-Transistor, 80 V IPT014N08NM5



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OptiMOS[™]5 Power-Transistor, 80 V IPT014N08NM5



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Devenuetos	Comb al	Values				Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - -	- - -	331 234 37	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm THJA}$ =40 °C/W ²)
Pulsed drain current ³⁾	I _{D,pulse}	-	-	1324	Α	<i>T</i> _C =25 °C
Avalanche energy, single pulse ⁴⁾	E AS	-	-	632	mJ	$I_{\rm D}$ =150 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	300	W	<i>T</i> _C =25 °C
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	IEC climatic category; DIN IEC 68-1: 55/175/56

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition	
Parameter	Syllibol	Min.	Тур.	Max.	Oilit	Note / Test Condition	
Thermal resistance, junction - case, bottom	R _{thJC}	-	0.27	0.5	°C/W	-	
Device on PCB, top	R _{thJA}	-	-	62	°C/W	-	
Device on PCB, 6 cm² cooling area ²⁾	R _{thJA}	-	-	40	°C/W	-	

¹⁾ Rating refer to the product only with data sheet specified absolute maximum values, maintaining case temperature at 25°C. For higher case temperature please refer to Diagram 2. De-rating will be required based on the actual

environment conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information

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3 Electrical characteristics

at T_j=25 °C, unless otherwise specified

Table 4 Static characteristics

Parameter.	0	Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	80	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	V _{GS(th)}	2.2	3.0	3.8	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 280 \ \mu {\rm A}$
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μΑ	V _{DS} =80 V, V _{GS} =0 V, T _j =25 °C V _{DS} =80 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I_{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	1.1 1.5	1.4 1.7	mΩ	V _{GS} =10 V, I _D =150 A V _{GS} =6 V, I _D =75 A
Gate resistance ¹⁾	R _G	-	1.4	2.1	Ω	-
Transconductance	g fs	160	240	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 100 A$

Table 5 Dynamic characteristics

Danamatan	Consolo a l		Values			N
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	Ciss	-	11000	14000	pF	V _{GS} =0 V, V _{DS} =40 V, f=1 MHz
Output capacitance ¹⁾	Coss	-	1800	2300	pF	V _{GS} =0 V, V _{DS} =40 V, f=1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	78	140	pF	V _{GS} =0 V, V _{DS} =40 V, f=1 MHz
Turn-on delay time	$t_{ m d(on)}$	-	32	_	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.8 Ω
Rise time	t _r	-	16.2	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.8 Ω
Turn-off delay time	$t_{ ext{d(off)}}$	-	61	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.8 Ω
Fall time	t _f	-	17.6	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.8 Ω

Table 6 Gate charge characteristics²⁾

Damanastan	Oh a l	Values			11	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	51	-	nC	$V_{\rm DD}$ =40 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate charge at threshold	$Q_{g(th)}$	-	34	-	nC	$V_{\rm DD}$ =40 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate to drain charge ¹⁾	$Q_{ m gd}$	-	34	50	nC	$V_{\rm DD}$ =40 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Switching charge	Q _{sw}	-	51	-	nC	$V_{\rm DD}$ =40 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total ¹⁾	Qg	-	160	200	nC	$V_{\rm DD}$ =40 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate plateau voltage	V _{plateau}	-	4.5	-	V	$V_{\rm DD}$ =40 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total, sync. FET	Q _{g(sync)}	-	138	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V
Output charge ²⁾	Qoss	-	187	249	nC	V _{DS} =40 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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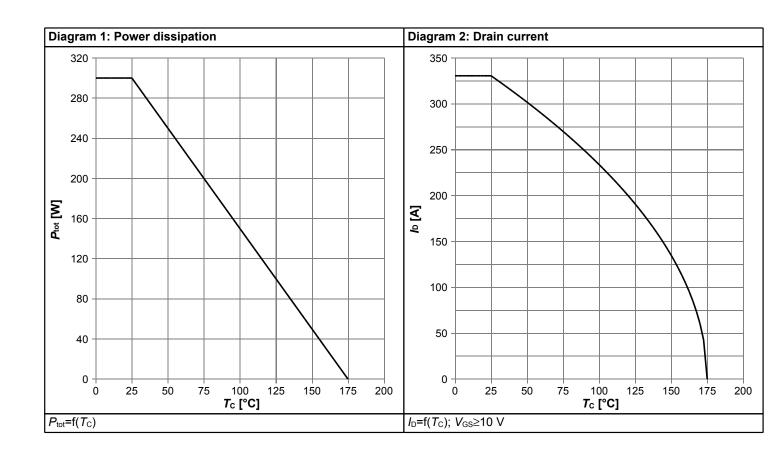


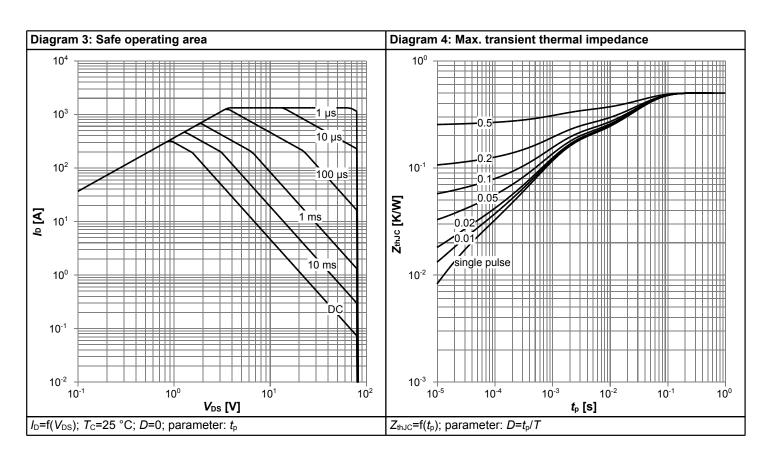
Table 7 Reverse diode

Davamatar	Cumbal		Values			Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continuous forward current	Is	-	-	213	Α	<i>T</i> _C =25 °C	
Diode pulse current	I _{S,pulse}	-	-	1324	Α	<i>T</i> _C =25 °C	
Diode forward voltage	V _{SD}	-	0.85	1.2	V	V _{GS} =0 V, I _F =100 A, T _j =25 °C	
Reverse recovery time ¹⁾	t _{rr}	-	60.5	121	ns	V_R =40 V, I_F =100 A, di_F/dt =100 A/ μ s	
Reverse recovery charge ¹⁾ Q _{rr}		-	169	338	nC	V _R =40 V, I _F =100 A, di _F /dt=100 A/μs	

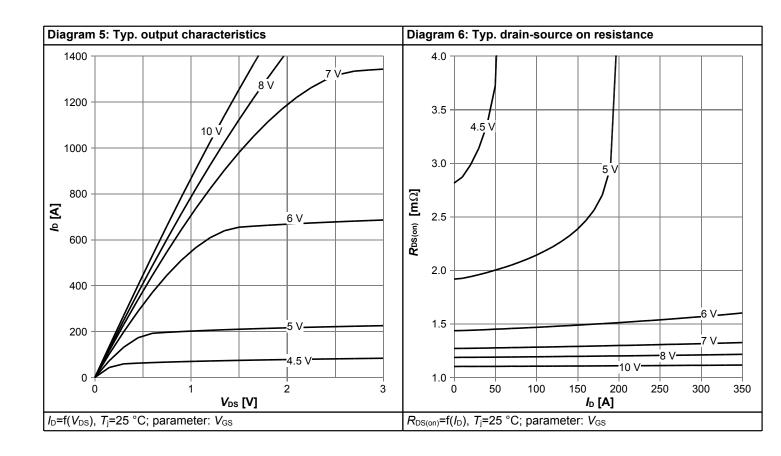


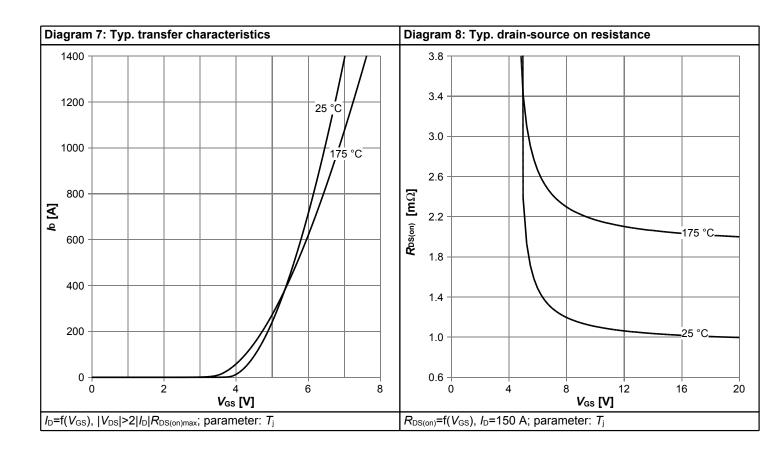
4 Electrical characteristics diagrams



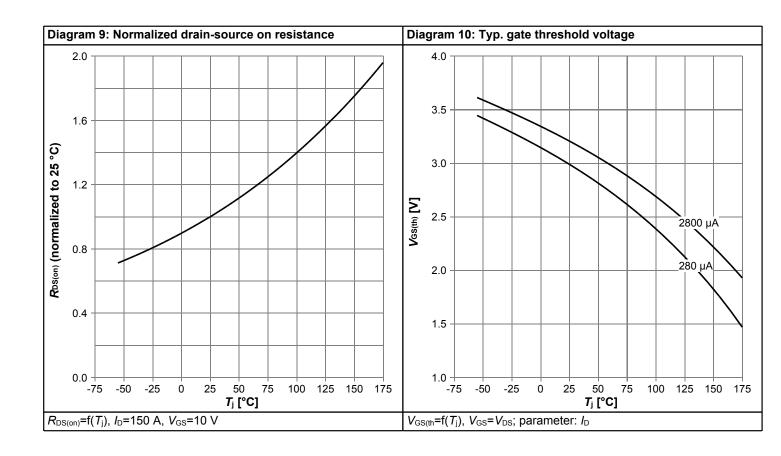


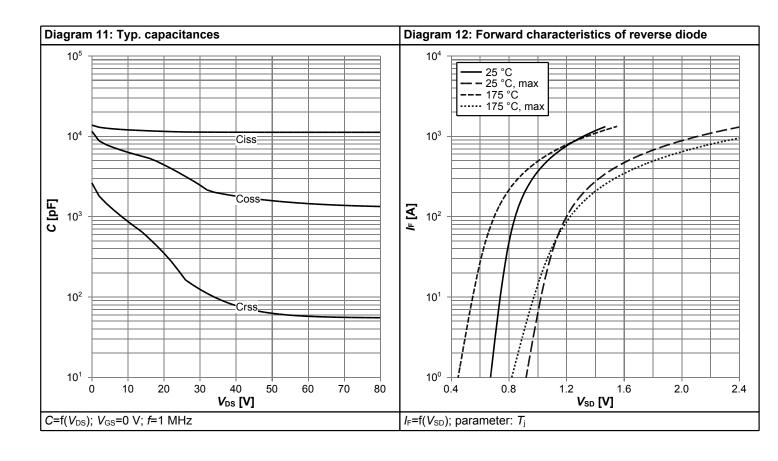




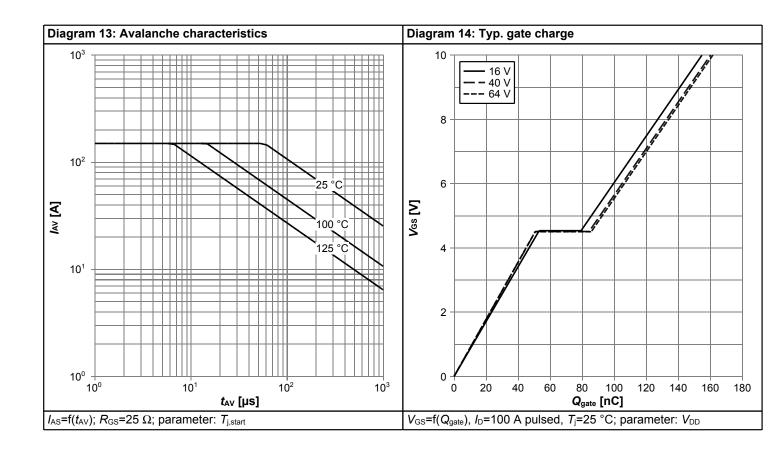


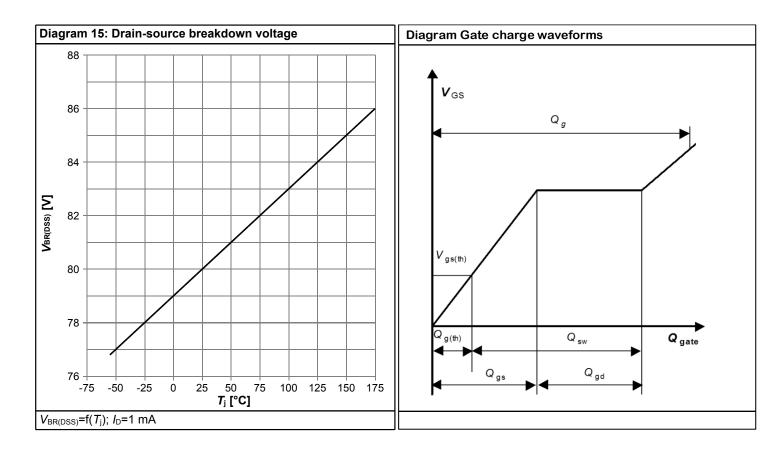














5 Package Outlines

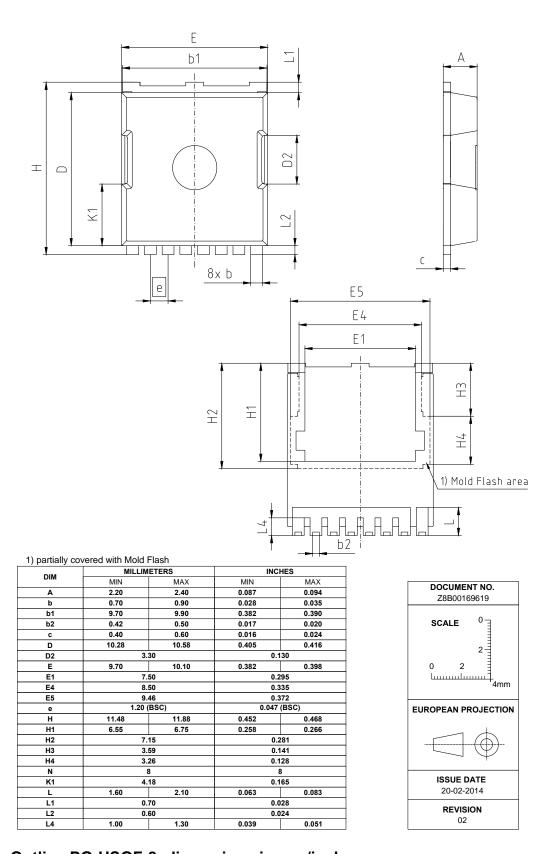


Figure 1 Outline PG-HSOF-8, dimensions in mm/inches

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Revision History

IPT014N08NM5

Revision: 2020-12-18, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)			
2.0	2020-12-18	Release of final version			

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